501873763 03/30/2012

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Chien-Wei Chiu	03/19/2012
Tsung-Yi Huang	03/19/2012

RECEIVING PARTY DATA

Name:	RICHTEK TECHNOLOGY CORPORATION	
Street Address:	5F, NO. 20, TAI YUEN STREET	
City:	CHUPEI CITY, HSIN-CHU	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13436665

CORRESPONDENCE DATA

 Fax Number:
 (248)540-4035

 Phone:
 248-540-4040

 Email:
 tungassoc@aol.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

via US Mail.

Correspondent Name: TUNG & ASSOCIATES / RANDY W. TUNG, ESQ.

Address Line 1: 838 W. LONG LAKE RD.

Address Line 2: SUITE 120

Address Line 4: BLOOMFIELD HILLS, MICHIGAN 48302

ATTORNEY DOCKET NUMBER: 92,000-304 (RH-1184)

NAME OF SUBMITTER: RANDY W TUNG

Total Attachments: 1

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PATENT REEL: 027967 FRAME: 0715 OF \$40.00 13436665

92000-304

RH-1184 V101-012

ASSIGNMENT

WHEREAS, I/we, Chien-Wei Chiu, and Tsung-Yi Huang, have invented certain improvements in:

"VERTICAL SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREOF"

for which I am/we are about to make application for Letters Patent of the United States; and
WHEREAS, Richtek Technology Corporation, a company having a business address
residing in R.O.C., is desirous of acquiring the entire right, title and interest in and to said invention;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, I/we, Chien-Wei Chiu. and Tsung-Yi Huang, by these presents, do hereby sell, assign and transfer unto the said corporation and its assigns. for the territory of the United States of America and all foreign countries, the entire right, title and interest, including all priority rights under the International Convention associated with each country of the Union, in and to said invention as described in the patent application executed by us on the following execution date, preparatory to obtaining Letters Patent of the United States thereon, and in and to said application and any Letters Patent that may be granted in pursuance of said application and any divisional, continuation or continuation-in-part application thereof, and in and to any reissue of any such patent, and in and to any patent applications which may be filed on said invention in countries foreign to the United States and any Letters Patent granted thereon.

I/we further authorize said corporation to apply for foreign patents on said invention in its own name or through its designees, including subsidiaries, related companies or assignees, under the International Convention or otherwise, and I/we further agree to execute all papers, including those required for the United States and foreign applications, and to perform such other proper acts as said corporation or its designees the rights herein assigned.

(Signature by first inventor/assignor)

(Date)

Tsung-Yi Huang 2012.03.19

(Signature by second inventor/assignor)

(Date)

TUNG & ASSOCIATES
838 W. Long Lake Road, Suite 120
Bloomfield Hills, Michigan 48302

PATENT REEL: 027967 FRAME: 0716

RECORDED: 03/30/2012